ALPHA[®] EF-6000

Rosin-Free, No-Clean Flux for Lead-Free & Tin-Lead Wave Soldering

Best-in-Class Performance Low Residue Alcohol Based Liquid Flux

ALPHA EF-6000 is an active, rosin-free, low solid, low residue liquid flux, specifically developed to deliver outstanding board cosmetics and to eliminate the tendency for solder balling and solder bridging, which are normally associated with rosin-free chemistries.

Of all low solids (< 4% solids), no-clean fluxes, **ALPHA EF-6000** exhibits the lowest tendency for solder ball generation over a wide variety of solder masks during wave soldering and selective soldering operations.

ALPHA EF-6000 should be considered for use by any assembler requiring minimal residues and pin testability, or whose specification requires an extremely low frequency of solder balls.



QFP Bridges Bridges per 0.65mm QFP 90 0 70 0 60 0 50 0 40 0 30 0 20 0 10 0 HASL Entek Plus OSP IO6AX SN63 Entek HT OSP Immersion Ag Entek Plus OSP IO6AX SAC 305 EF-6000 Leading Competitor

Excellent resistance to bridging across a broad range of process conditions.

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Key Features

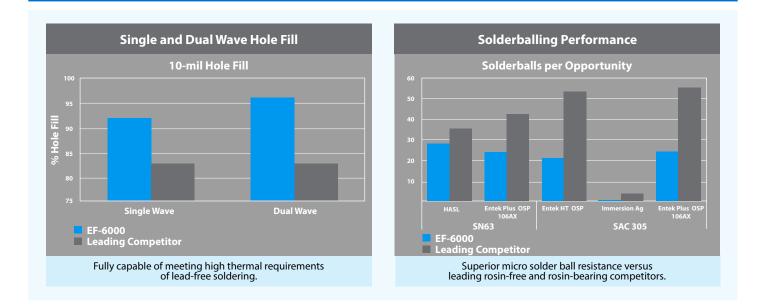
- Rosin-free, no-clean, alcohol-based.
- Fully lead-free capable ORL0.
- Broad process compatibility.
- IPC SIR 004A and Bellcore ECM compliant for long term electrical reliability.
- Extremely low equipment maintenance versus rosin-bearing fluxes.
- No false failures during in-line pin testing.



ASSEMBLY SOLUTIONS

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PERFORMANCE SUMMARY

BENEFIT	ALPHA EF-6000	PERFORMANCE CAPABILITY
PROCESS WINDOW	Dual-Alloy Performance	Wide Thermal Process Window enables high yields and Lead-Free and Tin-Lead Process.
	Broad Process Compatibility	One flux for all common board types and pad finishes.
HIGH PROCESS YIELD	Resistance to Micro-Solderball Formation	Increased reliability and reduction of electrical shorts. Provides industry leading performance.
	Resistance to Bridging	Best-in-class versus leading competitive products. Minimizes touch-up/rework of bottom side components.
	Hole-fill	Excellent Lead-Free and Tin-Lead yields versus leading competitive product.
	Residue Cosmetics	Clear, colorless residue. No rosin build-up on selective pallets.
	Equipment Maintenance	Very low cleaning/maintenance frequency versus rosin-bearing formulations.
	Pin Testability	100% First pass yield - Lead-Free & Tin-Lead.

ALPHA EF-6000 is a rosin-free, no-clean, alcohol-based liquid flux, specifically developed to deliver outstanding board cosmetics and to eliminate the tendency for solder balling and solder bridging.



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Alpha and Kester are a product brand of MacDermid Alpha Electronics Solutions.

SCAN THE CODE to know more

For more information, contact us at Assembly@MacDermidAlpha.com

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